

FORM PTO-1449 (MODIFIED)

LIST OF PUBLICATIONS FOR  
APPLICANT'S INFORMATION  
DISCLOSURE STATEMENT



Applicant(s): C.J. Miller et al.  
Case: 2-1  
Serial No.: 10/786,182  
Filing Date: February 25, 2004  
Group: 2812

U.S. PATENT DOCUMENTS

| EXAMINER | DOCUMENT NO. | DATE | NAME | CLASS/SUBCLASS | FILING DATE    |
|----------|--------------|------|------|----------------|----------------|
| INITIAL  |              |      |      |                | IF APPROPRIATE |

FOREIGN PATENT DOCUMENTS

| EXAMINER | DOCUMENT NO. | DATE | COUNTRY | CLASS/SUBCLASS | TRANSLATION |
|----------|--------------|------|---------|----------------|-------------|
| INITIAL  |              |      |         |                | YES NO      |

OTHER DOCUMENTS

| EXAMINER | REF NO. | AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC. |
|----------|---------|--|
| INITIAL  |         |  |

AKS 1. V. Solberg, "Adapting Fine-Line Flex Circuits for 3D Multiple Die Packaging," Semiconductor Manufacturing, pp. 94-108, June 2003.

Examiner

Date Considered

AsSh Umman Sarhar

11/7/05

Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.